Records Schedule Number: DAA-0167-2023-0001 Status: APPROVED Date Approved: 01/22/2025

General Information

Agency or Establishment	National Institute of Standards and Technology
Record/Scheduling Group	0167 - Records of the National Institute of Standards and Technology
Records Schedule Applies To	Agency-wide
Schedule Subject	CHIPS Loans, Loan Guarantee, and Other Transaction Agreement Records
Additional Schedule Information	The Creating Helpful Incentives to Produce Semiconductors (CHIPS) Program is administered by the CHIPS Program Office (CPO) and the CHIPS Research and Development (R&D) Office within the National Institute of Standards and Technology (NIST) of the U.S. Department of Commerce. The CHIPS Program aims to strengthen U.S. economic and national security, including economic resilience and competitiveness. Loans, Loan Guarantees, and other transaction agreements support the long-term growth and economic sustainability in the domestic semiconductor industry and workforce, promote the secure and resilient supply chains on which the sector relies, and enable advances in semiconductor research and development to extend America's leadership in semiconductor technology. The Federal funds serve as a catalyst to galvanize private, state, and local participation and investment in the semiconductor industry. This schedule covers records related to Loans and Loan Guarantees, as provided for in 15 U.S.C. § 4652, and other transaction agreements, as provided for in 15 U.S.C. § 4659.
Is There a Classified Version of This Schedule?	No
Is consultation and coordination with Tribal Governments required?	No - the records covered by this schedule do not implicate Tribal interests

Page 1 of 10 PDF Created on: 01/24/2025

Records Schedule Number: DAA-0167-2023-0001

Status: APPROVED
Date Approved: 01/22/2025

Item Count

Total number of disposition items: 6

Number of Temporary disposition items: 6

Number of Permanent disposition items: 0

Number of Items with Disposition Not Approved: 0

Number of Inactive disposition items: 0

Page 2 of 10 PDF Created on: 01/24/2025

Records Schedule Number: DAA-0167-2023-0001

Status: APPROVED Date Approved: 01/22/2025

Outline of Records Schedule Items for DAA-0167-2023-0001

Item #	Title	Disposition
0001	Loans and Loan Guarantees Program Management	Temporary
	Files	
0002	CHIPS Loans and Loan Guarantees - Approved	Temporary
	Applicants	
0003	CHIPS Loans and Loan Guarantees - Denied	Temporary
	Applicants	
0004	Other Transaction Agreement Program Management	Temporary
	Files	
0005	CHIPS Other Transaction Agreement - Approved	Temporary
0006	CHIPS Other Transaction Agreement - Denied	Temporary

Page 3 of 10 PDF Created on: 01/24/2025

Records Schedule Number: DAA-0167-2023-0001

Status: APPROVED
Date Approved: 01/22/2025

Records Schedule Items

STATUS: Active
Loans and Loan Guarantees Program Management Files
This consists of application package templates and other records related to the management of the Creating Helpful Incentives to Produce Semiconductors (CHIPS) program, including but not limited to:
 Background files, such as program announcements; Notice of Funding Opportunity Announcement(s), including any Federal Register notices; or requests for proposals. Application package for the statement of interest, preapplication, and full application (e.g., blank forms, instructions, guidelines, templates, checklists, evaluation criteria, etc.). Application evaluation files (e.g., panel composition, correspondence, instructions, scoring matrix and related instructions, conflict-of-interest statements from the various reviewers and panelists, etc.). Internally generated reports of the loan and loan guarantee program. Audit reports of the program.
No
ION AUTHORITIES AND GRS DEVIATIONS
No
No
Temporary
Cut off after Performance is complete, repayment, or
cancellation of all CHIPs financial assistance awards.
Other: Destroy 10 years after cutoff.
No
No

Page 4 of 10 PDF Created on: 01/24/2025

Records Schedule Number: DAA-0167-2023-0001 Status: APPROVED Date Approved: 01/22/2025

DAA-0167-2023-0001-0002	STATUS: Active
ITEM GENERAL INFORMATION	
Item Title	CHIPS Loans and Loan Guarantees - Approved Applicants
Item Description	Files include statements of interest, pre-application, and application packages such as an applicant's project plan, financial information, and other documents related to the application and award process including but not limited to, loan applications, application evaluation files, correspondence, and other records relating to successful applications such as award documents, loan agreements and related documentation, promissory notes, financial analyses, project implementation plans, scope of work, files related to the results of the review process, progress reports, disbursements, repayment schedules, amendment requests and approval of modifications, and applicable post-award reporting requirements.
Is this item media neutral?	Yes
Is this item a Big Bucket?	No
•	ION AUTHORITIES AND GRS DEVIATIONS
Does this item supersede existing disposition authorities?	No
Is this item a deviation from the GRS?	No
DISPOSITION INSTRUCTION	
Final Disposition	Temporary
Cutoff Instructions	Cut off after performance is complete, repayment, or cancellation of all CHIPs financial assistance awards.
Retention Period	Other: Destroy 10 years after cutoff.
ADDITIONAL INFORMATION	
Are any of the records covered by	No
this item national security classified?	
GAO Approval Required	No

DAA-0167-2023-0001-0003	STATUS: Active
ITEM GENERAL INFORMATION	
Item Title	CHIPS Loans and Loan Guarantees - Denied Applicants

Page 5 of 10 PDF Created on: 01/24/2025

Records Schedule Number: DAA-0167-2023-0001 Status: APPROVED Date Approved: 01/22/2025

Item Description	Files include statements of interest, pre-application, and application packages such as an applicant's project plan,
	financial information, and other documents related to the
	application and denial process including but not limited to, loan
	applications, application evaluation files, correspondence, and
	other records relating to unsuccessful (rejected or withdrawn)
	applications.
Is this item media neutral?	Yes
Is this item a Big Bucket?	No
SUPERSEDED AGENCY DISPOSIT	ION AUTHORITIES AND GRS DEVIATIONS
Does this item supersede existing	No
disposition authorities?	
Is this item a deviation from the	No
GRS?	
DISPOSITION INSTRUCTION	
Final Disposition	Temporary
Cutoff Instructions	Cut off after performance is complete, repayment, or cancellation
	of all CHIPs financial assistance awards.
Retention Period	Other: Destroy 7 years after cutoff.
ADDITIONAL INFORMATION	
Are any of the records covered by	No
this item national security	
classified?	
GAO Approval Required	No

DAA-0167-2023-0001-0004	STATUS: Active
ITEM GENERAL INFORMATION	
Item Title	Other Transaction Agreement Program Management Files
Item Description	An Other Transaction Authority is a legally binding agreement
	between the federal government and another party that is not a
	grant, cooperative agreement, or federal contract. This is used to
	streamline projects like research and development, prototype
	development and other projects involving research. This is
	different from loan agreements. consist of application package
	templates and other records related to the management of the
	Creating Helpful Incentives to Produce Semiconductors (CHIPS)
	program Including but not limited to:
	Background files, such as program announcements; Notice of
	Funding Opportunity Announcement(s), including any Federal
	Register notices; or requests for proposals.

Page 6 of 10 PDF Created on: 01/24/2025

Records Schedule Number: DAA-0167-2023-0001 Status: APPROVED Date Approved: 01/22/2025

1	• Application package for the statement of interest, pre-
	application, and full application (e.g., blank forms, instructions,
	guidelines, templates, checklists, evaluation criteria, etc.).
	 Application evaluation files (e.g., panel composition,
	correspondence, instructions, scoring matrix and related
	instructions, conflict-of-interest statements from the various
	reviewers and panelists etc.).
	• Internally generated reports of the other transaction agreement
	program.
	Audit reports of the program.
	rudit reports of the program.
	NOTE: Not all other transaction agreements application
	packages originate from notice of funding opportunities or
	solicitations. Some application package documents are not
	required for certain types of other transaction agreements.
Is this item media neutral?	Yes
Is this item a Big Bucket?	No
	ION AUTHORITIES AND GRS DEVIATIONS
Does this item supersede existing	No
disposition authorities?	
Is this item a deviation from the	No
GRS?	
DISPOSITION INSTRUCTION	
Final Disposition	Temporary
Cutoff Instructions	Cut off after performance is complete, repayment, or cancellation
	of all CHIPs financial assistance awards.
Retention Period	Other: Destroy 10 years after cutoff.
ADDITIONAL INFORMATION	
Are any of the records covered by	No
Are any of the records covered by this item national security	No
1	No

DAA-0167-2023-0001-0005	STATUS: Active
ITEM GENERAL INFORMATION	
Item Title	CHIPS Other Transaction Agreement - Approved

Page 7 of 10 PDF Created on: 01/24/2025

Records Schedule Number: DAA-0167-2023-0001

Status: APPROVED
Date Approved: 01/22/2025

Item Description	Files include statements of interest, pre-application, and application packages such as an applicant's project plan, financial information, and other documents related to the application and award process, including but not limited to, application evaluation files and related documentation, assessments, financial analyses, scope of work, project implementation plans, negotiations, correspondence, results of the review process, award documents, progress reports, disbursements, amendment requests and approval of modifications, and applicable post-award reporting requirements.
Is this item media neutral?	Yes
Is this item a Big Bucket?	No
SUPERSEDED AGENCY DISPOSITI	ON AUTHORITIES AND GRS DEVIATIONS
Does this item supersede existing disposition authorities?	No
Is this item a deviation from the GRS?	No
DISPOSITION INSTRUCTION	
Final Disposition	Temporary
Cutoff Instructions	Cut off after performance is complete, repayment, or cancellation
	of all CHIPs financial assistance awards.
Retention Period	Other: Destroy 10 years after cutoff.
ADDITIONAL INFORMATION	
Are any of the records covered by	No
this item national security classified?	
GAO Approval Required	No

DAA-0167-2023-0001-0006	STATUS: Active
ITEM GENERAL INFORMATION	
Item Title	CHIPS Other Transaction Agreement - Denied
Item Description	Files include statements of interest, pre-application, and
	application packages such as an applicant's project plan,
	financial information, and other documents related to the
	application and denial process including but not limited to, other
	transaction agreement applications, application evaluation files,
	correspondence, and other records relating to unsuccessful
	(rejected or withdrawn) applications.
Is this item media neutral?	Yes
Is this item a Big Bucket?	No
SUPERSEDED AGENCY DISPOSIT	ION AUTHORITIES AND GRS DEVIATIONS

Page 8 of 10 PDF Created on: 01/24/2025

Records Schedule Number: DAA-0167-2023-0001 Status: APPROVED Date Approved: 01/22/2025

Does this item supersede existing disposition authorities?	No
Is this item a deviation from the GRS?	No
DISPOSITION INSTRUCTION	
Final Disposition	Temporary
Cutoff Instructions	Cut off after performance is complete, repayment, or cancellation
	of all CHIPs financial assistance awards.
Retention Period	Other: Destroy 7 years after cutoff.
ADDITIONAL INFORMATION	
Are any of the records covered by	No
this item national security	
classified?	
GAO Approval Required	No

Page 9 of 10 PDF Created on: 01/24/2025

Records Schedule Number: DAA-0167-2023-0001 Status: APPROVED Date Approved: 01/22/2025

Signatory Information

Action	User	Date
Approve	Colleen Shogan	01/22/2025

Page 10 of 10 PDF Created on: 01/24/2025